TE Internal #: 55825-1

Splices, 16 – 14 AWG Wire Size, 1.25 – 2 mm² Wire Size, Sealable, .

19 in [4.83 mm] Barrel Inside Diameter, 2050 – 5180 CMA Wire Size,

Copper, Blue

View on TE.com >



Terminals & Splices > Splices



Wire Size: 1.25 – 2 mm<sup>2</sup>

Sealable: Yes

Accepts Wire Insulation Diameter Range: 4.83 mm [.19 in]

Barrel Inside Diameter: 4.83 mm [ .19 in ]

### **Features**

### **Product Type Features**

Sealable	Yes
Splice Type	Butt Splice
Serrated	No
Compatible With Discrete Wire Type	Stranded
Wire Insulation Support Retention Type	Insulation Support

### **Configuration Features**

Compatible With Wire & Cable Type	Discrete Wire
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### **Body Features**

Insulation Sleeve Material	Polyolefin
Weight per Piece	1.149 g
Plating Material	Tin, Unplated
Primary Product Material	Copper
Primary Product Color	Blue

### **Contact Features**

Contact Plating Material	Tin
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Barrel Type	Closed
Mechanical Attachment	
Wire Insulation Support	With
Dimensions	
Wire Size	2050 – 5180 CMA
Accepts Wire Insulation Diameter Range	4.83 mm[.19 in]
Barrel Inside Diameter	4.83 mm[.19 in]
Overall Product Length	40.79 mm[1.606 in]
Usage Conditions	
Insulation Option	Fully Insulated
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Heavy Duty	No
Industry Standards	
Government Qualified Splice	No
Packaging Features	
Packaging Quantity	1000
Packaging Method	Loose Piece
Other	
Military Category	No

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free



#### Solder Process Capability

Not applicable for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**









# Customers Also Bought

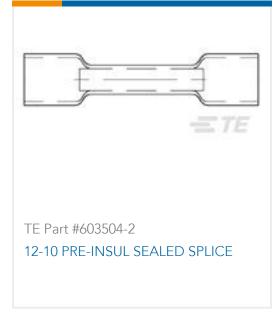




















### **Documents**

### **Product Drawings**

16-14 PRE-INSUL SEALED SPLICE

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_55825-1\_K.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_55825-1\_K.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_55825-1\_K.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Environmental Compliance**

TE Material Declaration

English

## **Instruction Sheets**

Instruction Sheet (U.S.)

English